

Small Surface Mount Ultrafast Diodes

Features

- · For surface mounted applications
- · Low profile package
- · Ideal for automated placement
- · Glass passivated
- High temperature soldering: 260 °C/ 10 seconds at terminals
- Lead (Pb)-free component
- Component in accordance to RoHS 2002/95/EC and WEEE 2002/96/EC

Mechanical Data

Case: JEDEC DO-219AB (SMF®) Plastic case

Polarity: Band denotes cathode end

Weight: approx. 15 mg

Pk





17249

Packaging codes-options:

GS18 / 10 K per 13" reel (8 mm tape), 50 k/box GS08 / 3 K per 7" reel (8 mm tape), 30 k/box

Parts Table

Part Ordering code		Marking	Remarks		
ES07B	ES07B-GS18 or ES07B-GS08	EB	Tape and Reel		
ES07D	ES07D-GS18 or ES07D-GS08	ED	Tape and Reel		

Absolute Maximum Ratings

T_{amb} = 25 °C, unless otherwise specified

Parameter	Test condition	Part	Symbol	Value	Unit
Maximum repetitive peak reverse voltage		ES07B	V _{RRM}	100	V
		ES07D	V _{RRM}	200	V
Maximum RMS voltage		ES07B	V _{RMS}	70	V
		ES07D	V _{RMS}	140	V
Maximum DC blocking voltage		ES07B	V _{DC}	100	V
		ES07D	V_{DC}	200	V
Maximum average forward rectified current	T _{tp} = 105 °C		I _{F(AV)}	1.2	Α
	T _A = 65 °C ¹⁾		I _{F(AV)}	0.5	Α
Peak forward surge current 8.3 ms single half sine-wave	T _L = 25 °C		I _{FSM}	30	А

¹⁾ Mounted on epoxy glass PCB with 3 x 3 mm, Cu pads (\geq 40 μm thick)

Thermal Characteristics

 T_{amb} = 25 °C, unless otherwise specified

Parameter	Test condition	Symbol	Value	Unit
Thermal resistance junction to ambient air 1)		R_{thJA}	180	K/W
Operating junction and storage temperature range		T _J , T _{STG}	- 55 to + 150	°C

¹⁾ Mounted on epoxy glass PCB with 3 x 3 mm, Cu pads (≥ 40 µm thick)

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Electrical Characteristics

T_{amb} = 25 °C, unless otherwise specified

Parameter	Symbol	Min	Typ.	Max	Unit	
Maximum instantaneous forward voltage	1.0 A ³⁾	V _F			0.98	V
Maximum DC reverse current at rated DC blocking voltage	T _A = 25°C	I _R			10	μА
	T _A = 100°C	I _R			50	μΑ
Reverse recovery time	$I_F = 0.5 \text{ A}, I_R = 1 \text{ A}, I_{rr} = 0.25 \text{ A}$	t _{rr}			25	ns
Typical capacitance	4 V, 1 MHz	C _j		4		pF

 $^{^{3)}}$ Pulse test, 300 μs pulse with 1 % duty cycle

Typical Characteristics (Tamb = 25 °C unless otherwise specified)

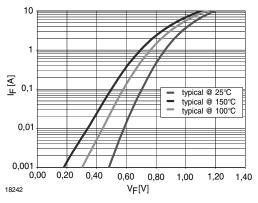


Figure 1. Typical Forward Characteristics

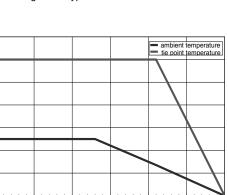


Figure 2. Forward Current Derating Curve

Temperature (Ambient or Tie) [°C]

100

125

150

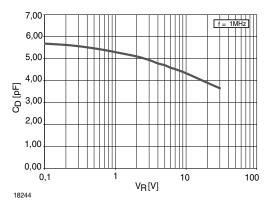


Figure 3. Typ. Diode Capacitance vs. Reverse Voltage

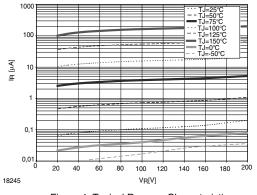


Figure 4. Typical Reverse Characteristics

1,4

Eorward Current [A]

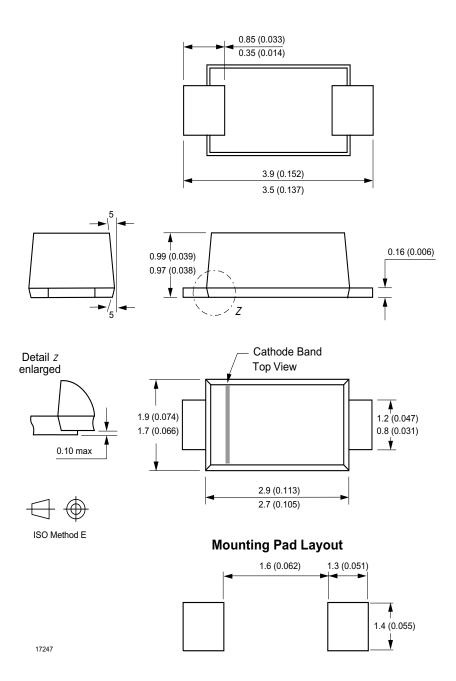
Average 7.0,2

0,0

18243

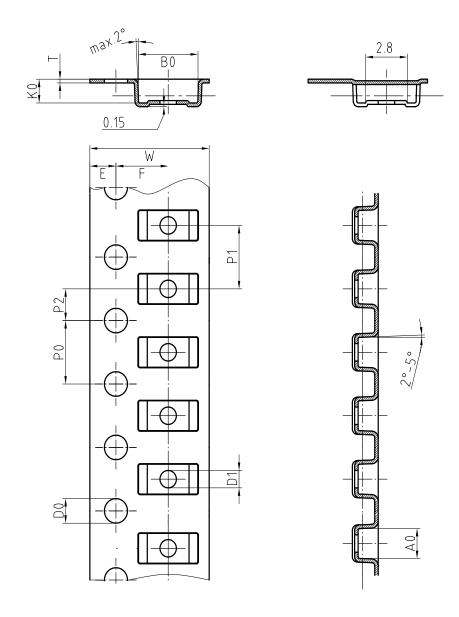


Package Dimensions in mm (Inches)



Blistertape for SMF





Mat	Α0	В0	K0	W	T	P0	P2	P1	D0	D1	E	F
PS	1.9	4.0	1.5	8.0	0.235	4.0	2.0	4.0	1.5	1	1.75	3.5

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Ozone Depleting Substances Policy Statement

It is the policy of Vishay Semiconductor GmbH to

- 1. Meet all present and future national and international statutory requirements.
- 2. Regularly and continuously improve the performance of our products, processes, distribution and operating systems with respect t their impact on the health and safety of our employees and the public, as well as their impact on the environment.

It is particular concern to control or eliminate releases of those substances into the atmosphere which are known as ozone depleting substances (ODSs).

The Montreal Protocol (1987) and its London Amendments (1990) intend to severely restrict the use of ODSs and forbid their use within the next ten years. Various national and international initiatives are pressing for an earlier ban on these substances.

Vishay Semiconductor GmbH has been able to use its policy of continuous improvements to eliminate the use of ODSs listed in the following documents.

- 1. Annex A, B and list of transitional substances of the Montreal Protocol and the London Amendments respectively
- 2. Class I and II ozone depleting substances in the Clean Air Act Amendments of 1990 by the Environmental Protection Agency (EPA) in the USA
- 3. Council Decision 88/540/EEC and 91/690/EEC Annex A, B and C (transitional substances) respectively. Vishay Semiconductor GmbH can certify that our semiconductors are not manufactured with ozone depleting substances and do not contain such substances.

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